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Part Number: 0879180301

Status: Active

Overview: MiniDIMM Sockets

Description: 0.60mm Pitch miniDIMM DDR3 Socket, Surface Mount, Right-Angle, 1.5V Key, 244

Circuits, Natural (Off White) Latch, Lead-Free

**Documents:** 

3D ModelApplication Specification AS-87782-001-001 (PDF)Drawing (PDF)Packaging Specification PK-87918-002 (PDF)

Product Specification PS-87918-001-001 (PDF)

RoHS Certificate of Compliance (PDF)

**Agency Certification** 

CSA LR19980 UL E29179

Application tooling part link

Application Tooling Part Link 62100-1900 Application Tooling Part Link 62100-1950

General

Product Family Memory Module Sockets

Series 87918
Component Type Socket
Electrical Model Yes
JEDEC Outline MO-244

Overview <u>MiniDIMM Sockets</u>

Product Name MiniDIMM UPC 883906425876

**Physical** 

Circuits (Loaded) 244

Durability (mating cycles max) 25

Entry Angle 90° Angle (Side Entry)

Flammability 94V-0
Housing Color Black
Keying to Mating Part Yes

Latch Color Natural (Off-White)
Material - Metal Copper Alloy

Material - Plating Mating Gold Material - Plating Termination Tin

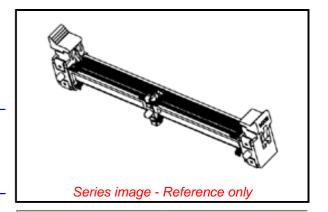
Material - Resin High Temperature Thermoplastic Net Weight 9.880/g

Net Weight **PCB** Locator Yes **PCB** Retention Yes PCB Thickness - Recommended 1.57mm Packaging Type Tray Pitch - Mating Interface 0.60mm Plating min - Mating 0.762µm Plating min - Termination 2.540µm Temperature Range - Operating -55° to +85°C Termination Interface: Style Surface Mount

**Electrical** 

Current - Maximum per Contact 1.0A Voltage - Maximum 30V Voltage Key 1.5V

**Solder Process Data** 



**EU ELV** 

**Not Relevant** 

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -ED/71/2019 (16 July 2019)

Halogen-Free

**Status** 

Not Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

**Search Parts in this Series** 

87918 Series

**Mates With** 

JEDEC MO-244 Modules

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description Product # MiniDIMM Memory 621001900

Card Extraction Tool

MiniDIMM Memory 621001950

Card Insertion Tool

Duration at Max. Process Temperature (seconds) 010

Lead-freeProcess Capability SMC&WAVE

Max. Cycles at Max. Process Temperature 002
Process Temperature max. C 260

#### **Material Info**

### **Reference - Drawing Numbers**

Application Specification AS-87782-001-001

Electrical Model Document EE-87918-001, EE-87918-003

Packaging Specification PK-87918-002
Product Specification PS-87918-001-001

S-Parameter Model SP-87918-001, SP-87918-003

Sales Drawing SD-87918-001 Signal Integrity Report RSI-87918-001

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